PATENT NUMBER and ISSUE DATE

## U.S. UTILITY Patent Application

APPL NUM	FILING DATE		SUBCLASS	1 1	EXAMINER	
10078718	02/19/2002	439	四年:	2833	360 1/2 -1	
**APPLICAN	TS: Yeo Yo	ng; Khan	Navas; Iyer M	ahadev	an;	
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Foreign priority clain 35 USC 119 condi		□ yes :			ATTORNEY DOCKET NO	
Verified and Acknow	vledged Examiners's inti	als			4795-002	
TITLE : Enhance	ed chip scale packa	ge for wir	e bond dies		U.C.DCOT. OF CO	
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